

GaAs MULTI-CHIP MODULE MC-7847

870 MHz CATV 25 dB POWER DOUBLER AMPLIFIER

DESCRIPTION

The MC-7847 is a GaAs Multi-chip Module designed for use in CATV applications up to 870 MHz. This unit has low distortion, low noise figure and return loss across the entire frequency band.

Reliability and performance uniformity are assured by our stringent quality and control procedures.

FEATURES

- · Low distortion
- High linear gain
- GL = 25.0 dB MIN. @f = 870 MHz Low return loss

<R> **ORDERING INFORMATION**

| Part Number | Order Number | Package | Supplying Form |
|-------------|--------------|--|------------------|
| MC-7847 | MC-7847-AZ | 7-pin special with heatsink (Pb-Free) | 25 pcs MAX./Tray |

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: MC-7847-AZ

ABSOLUTE MAXIMUM RATINGS ($T_A = +25^{\circ}C$)

| Parameter | Symbol | Ratings | Unit |
|----------------------------|--------|-------------|------|
| Supply Voltage | Vdd | 30 | V |
| Input Voltage Note | Vi | 65.0 | dBmV |
| Operating Case Temperature | Тс | -30 to +100 | °C |
| Storage Temperature | Tstg | -40 to +100 | °C |

Note In case of single tone

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

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The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

RECOMMENDED OPERATING CONDITIONS (Zs = Z_L = 75 Ω)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|----------------------------|--------|--|------|------|------|------|
| Supply Voltage | Vdd | | 23.5 | 24.0 | 24.5 | V |
| Input Voltage | Vi | 110 channel, 10 dB tilted across the band | _ | 29.0 | 32.0 | dBmV |
| Operating Case Temperature | Tc | | -30 | +25 | +85 | °C |

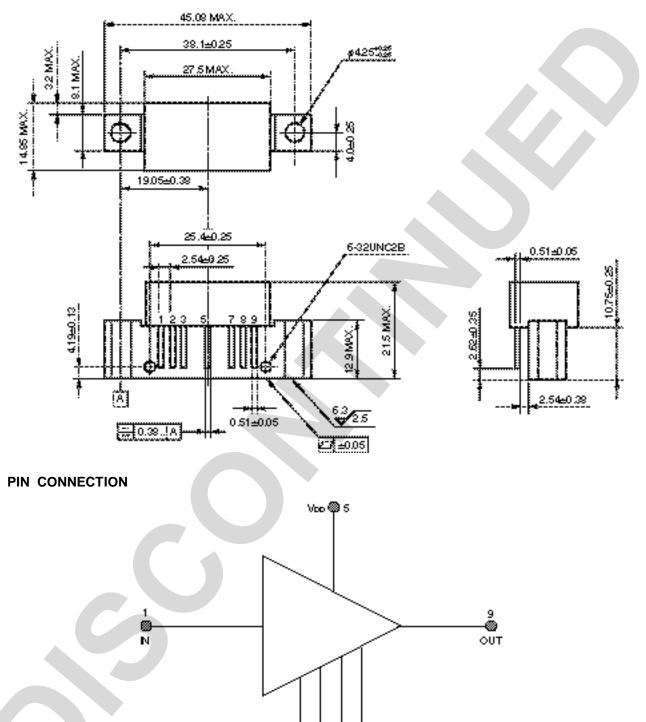
ELECTRICAL CHARACTERISTICS (Tc = $30 \pm 5^{\circ}$ C, Vdd = 24 V, Zs = ZL = 75Ω)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|--------------------------|-----------|---|------|------|------|------|
| Linear Gain | G∟ | f = 870 MHz | 25.0 | | 26.0 | dB |
| Gain Slope | GSlope | f = 40 to 870 MHz | 1.0 | 1.4 | 1.8 | dB |
| Gain Flatness | GFlatness | f = 40 to 870 MHz, Peak to valley | - | - | 0.6 | dB |
| Noise Figure 1 | NF1 | f = 50 MHz | - | - | 5.5 | dB |
| Noise Figure 2 | NF2 | f = 870 MHz | - | - | 6.0 | dB |
| Operating Current | IDD | RF OFF | 275 | - | 375 | mA |
| Composite Triple Beat | СТВ | 110 channel, | - | - | -60 | dBc |
| Cross Modulation | XM | Vo = 50 dBmV at 745.25 MHz, 10 dB tilted across the band | - | - | -55 | dBc |
| Composite 2nd Order Beat | CSO | | - | - | -63 | dBc |
| Input Return Loss 1 | RLi1 | f = 40 to 160 MHz | 20 | - | - | dB |
| Input Return Loss 2 | RLi2 | f = 160 to 320 MHz | 20 | - | - | dB |
| Input Return Loss 3 | RLi3 | f = 320 to 640 MHz | 19 | - | - | dB |
| Input Return Loss 4 | RLi4 | f = 640 to 870 MHz | 17 | - | - | dB |
| Output Return Loss 1 | RLo1 | f = 40 to 160 MHz | 20 | - | - | dB |
| Output Return Loss 2 | RLo2 | f = 160 to 320 MHz | 20 | I | - | dB |
| Output Return Loss 3 | RLo3 | f = 320 to 640 MHz | 19 | - | - | dB |
| Output Return Loss 4 | RLo4 | f = 640 to 870 MHz | 18 | - | - | dB |

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PACKAGE DIMENSIONS

7-PIN SPECIAL WITH HEATSINK (UNIT: mm)



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7/7 GND

NOTE ON CORRECT USE

- (1) The space between PC board and root of the lead should be kept more than 1 mm to prevent undesired stress to the lead and also should be kept less than 4 mm to prevent undesired parasitic inductance. Recommended that space is 2.0 to 3.0 mm typical.
- (2) Recommended torque strength of the screw is 59 to 78 Ncm.
- (3) Form the ground pattern as wide as possible to minimize ground impedance.
 (to prevent undesired oscillation)
 All the ground pins must be connected together with wide ground pattern to decrease impedance difference.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered in the following recommended conditions. Other soldering methods and conditions than the recommended conditions are to be consulted with our sales representatives.

| Soldering Method | Soldering Conditions | Condition Symbol | | |
|------------------|--|------------------|--|--|
| Pin Part Heating | Pin area temperature : less than 350°C ^{Note} Hour : Within 3 sec./pin | - | | |

Note The point of pin part heating must be kept more than 1.2 mm distance from the root of lead.

| Caution GaAs Products | This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. |
|-----------------------|---|
| | • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. |
| | Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. |
| | 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. |
| | Do not burn, destroy, cut, crush, or chemically dissolve the product. |
| | Do not lick the product or in any way allow it to enter the mouth. |